DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office addrest believe I am the original, first inventor (if plural names are lissought on the invention entitled PRODUCING LAMINATED EL unless the following box is chemically addressed in the second	and sole inventor (if only or ted below) of the subject m I <u>METHOD OF FORMING</u> <u>ECTRONIC COMPONEN</u>	ne name is listed below) or a latter which is claimed and for THICK-FILM WIRING AND	n original, or which a p METHOD (oatent is OF		
was filed onApplication Number	as Un and wa	as United States Application Number or PCT International and was amended on (if applicable).				
I hereby state that I have review including the claims, as amend			d specificat	tion,		
I acknowledge the duty to discl	ose information which is m	aterial to patentability as def	ined in 37	CFR § 1.56.		
for patent or inventor's certifica one country other than the Unit for patent or inventor's certifica	reby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least country other than the United States, listed below and have also identified below any foreign application patent or inventor's certificate, or PCT International application having a filing date before that of the ication on which priority is claimed.					
Prior Foreign Application(s)		Priority Date	Priority Claimed			
2002-353772	Japan	December 5, 2002	Yes	No		
(Number)	(Country) (PCT)	(Day/Month/Year Filed)				
2003-353100	Japan	October 14, 2003	_ Yes	No		
(Number)	(Country) (PCT)	(Day/Month/Year Filed)	\boxtimes			
I hereby claim the benefit unde below.	r 35 U.S.C. § 119(e) of any	· ·	pplication(s	s) listed		
(Application Number)		(Filing Date)				
(Application Number)		(Filing Date)				

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

KEATING&BENNETT P.03/03

(Application Number)		(Filing Date)		(Status – patented, pending, abandoned)	
(Application Numb r)		(Filing Date)		(Status – patented, pending, abandoned)	
I hereby appoint the fo business in the Patent	ollowing attorned and Tradema	ey(s) and/or agent(s) to pro rk Office connected therew	secute this application	on and to transact all	
Joseph R. Keating, Re Christopher A. Bennet	eg. No. 37,368 t, Reg. No. 46	3 3,710			
Address all correspondence to: Keating & Bennett LLP 10400 Eaton Place, Suite 312 Fairfax, VA 22030 (703) 385-5200			312		
on information and be knowledge that willful under Section 1001 of	lief are believe false statemen Title 18 of the	made herein of my own kno ed to be true; and further the nts and the like so made an e United States Code and the tion or any patent issued th	at these statements of punishable by fine nat such willful false :	were made with the or imprisonment, or both,	
Full name of first inve		me, family name) <u>Tetsuy</u>			
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